Nb Electropolishing R&D

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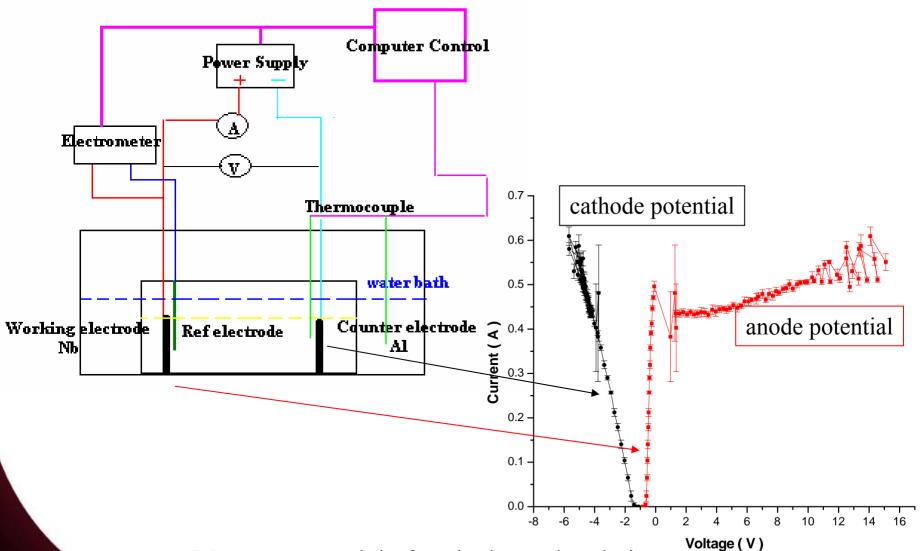
Objectives:

- Improve the electrochemical characterization of the Nb HF/H₂SO₄ EP process.
 - No agitation, controlled temperature and concentration
 - Flow conditions typical of cavity processing
- Establish the dependence of lateral scale of leveling on local process conditions.

In order to:

• Provide an improved technical basis for designing processes for specific effect, e.g. 9-cell cavities with < 20 nm roughness on 50 µm scale, over entire surface.

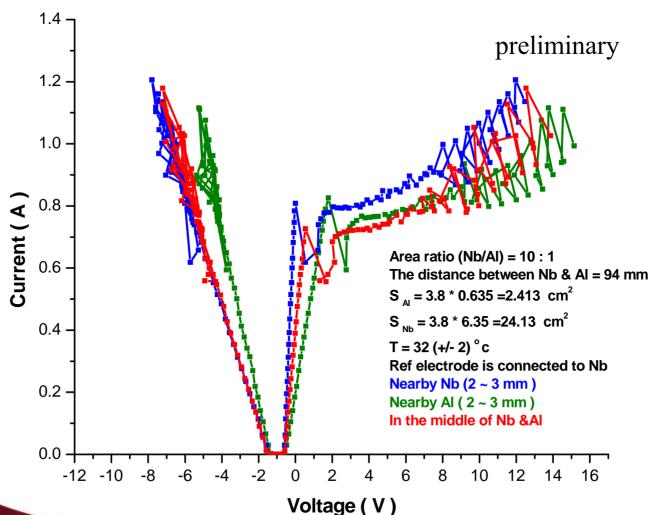




Measure potential of each electrode relative to a reference electrode (SCE) in the bath.



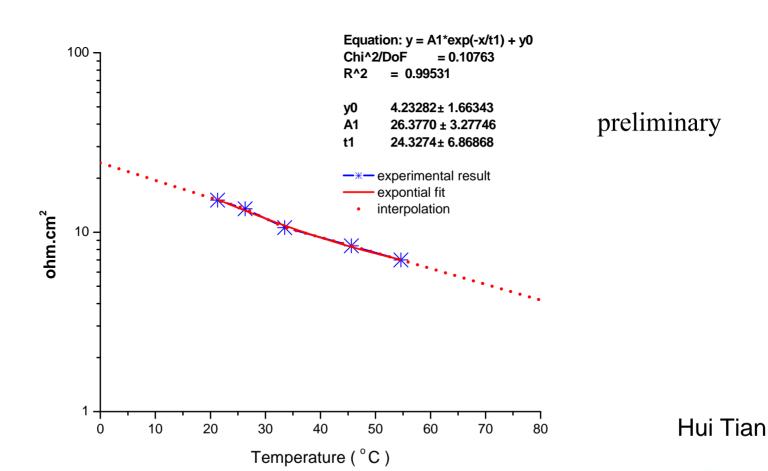
- Resistivity of bath measured by moving the reference electrode.
- For $T_{bath} = 32$ C, 9.4 cm separation, and typical current densities, a bath resistivity of $\sim 8 \Omega$ -cm² / cm has been observed.



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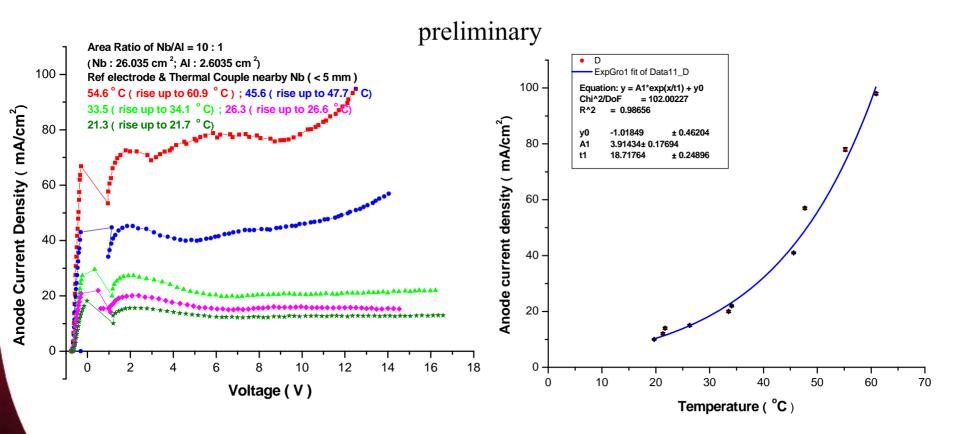


- The cathode polarization voltage is quite linear.
- The temperature dependence of this resistance is exponential.





• The anode plateau current density increases exponentially with temperature.

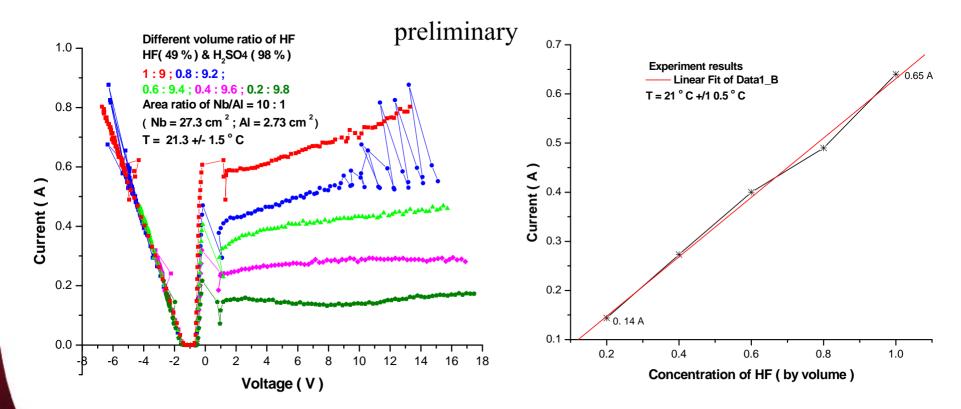


(Cavity wall temperatures have been measured to vary between 40-50 C during EP, while the exiting electrolyte temperature is regulated to 30 C. Consider the implications for the uniformity of polishing.)

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• The plateau current increases linearly with HF concentration (by volume).



This is consistent with characterizing the process as "acceptor-diffusion-limited". If so, the polishing effect is created by the gradient in F⁻ concentration near the surface.

Next steps

- Incorporate fluid flow adjacent to the anode by making a rotating anode assembly, look at the effect of "gentle" flow and in /out of bath as occurs in horizontal rotating cavity.
- Characterize the specific scales of smoothing effects for well-controlled EP conditions via profilometry & AFM.

